



IFU

MS Amendment  
Attorney Docket No. 82544

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of

Wei-Chi LIU et al.

Serial No. 10/698,476

Filed: November 3, 2003

For: **THERMAL DISSIPATING ELEMENT OF CHIP**

**TRANSMITTAL LETTER**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Submitted herewith for filing in the U.S. Patent and Trademark Office is the following:

(1) Response and Amendment

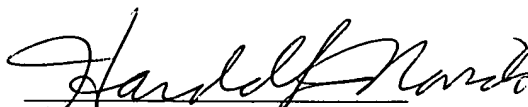
If an Extension of Time under 37 CFR § 1.136 is required and has not been separately requested herein, please consider this Transmittal Letter as including a request for such Extension of Time and as a further authorization to charge any fee for such Extension of Time, as may be required by 37 CFR § 1.17, to Deposit Account No. 14-0112.

Please charge any fee deficiency, or credit any overpayment, in connection with this matter to Deposit Account No. 14-0112.

Respectfully submitted,

NATH & ASSOCIATES PLLC

Date: December 9, 2004  
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MS Amendment  
Appl. No. 10/698,476  
Attorney Docket No. 82544

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Appl. No. : 10/698,476  
Applicant : Wei-Chi Liu, et al.  
Filed : November 3, 2003  
Title : **Thermal Dissipating Element of Chip**  
TC/A.U. : 2811  
Examiner : PAREKH, NITIN

Honorable Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**RESPONSE AND AMENDMENT**

Sir:

This paper is a full and complete response to the Official Action mailed September 9, 2004. The time period for response was set to expire December 9, 2004, which makes this a timely filed response to the outstanding Office Action. Applicants respectfully request that the Examiner reconsider the amended application according to the following remarks.

Please amend the above-identified application as follows:

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims, which begin on page 3 of this paper.

**Remarks/Arguments** begin on page 7 of this paper.